

标 记 MARK	ECN编号/变更内容 ECN NO/DEFINITION	修 改 REVISE	日 期 DATE	核 准 APPROVE

A

B

C

D

E

F

G

A

B

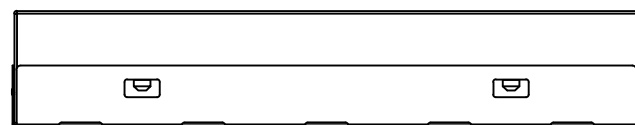
C

D

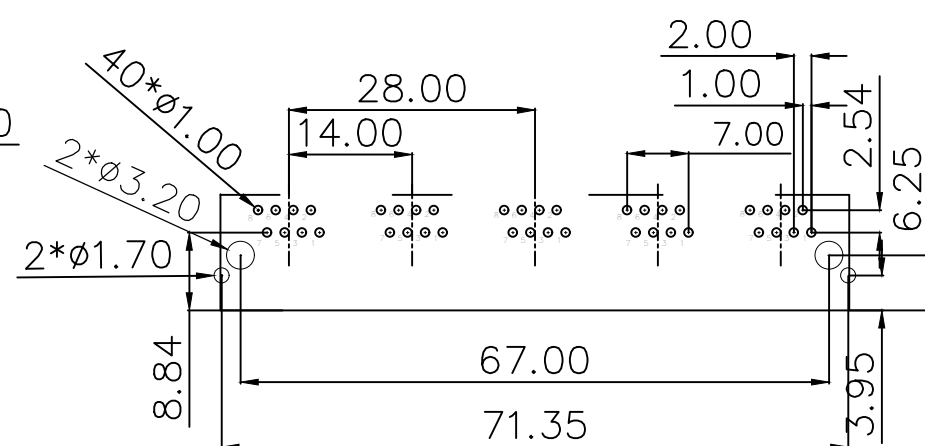
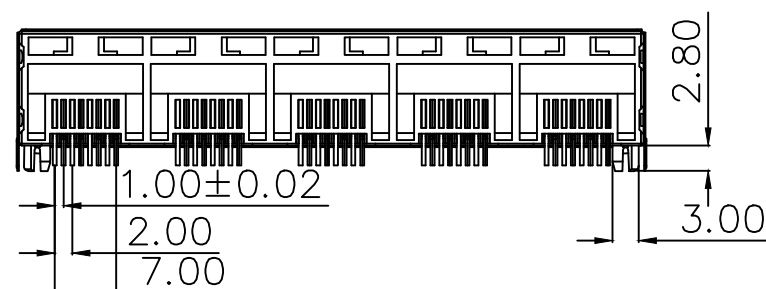
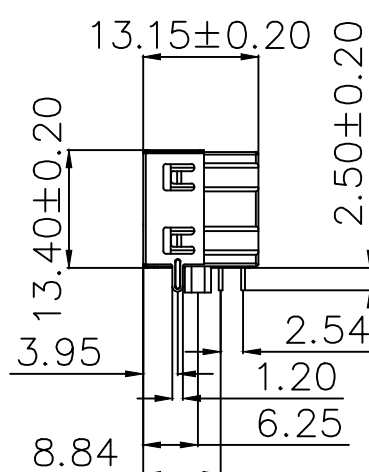
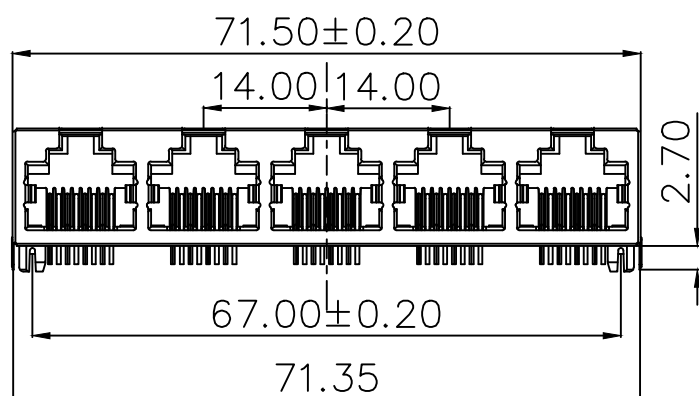
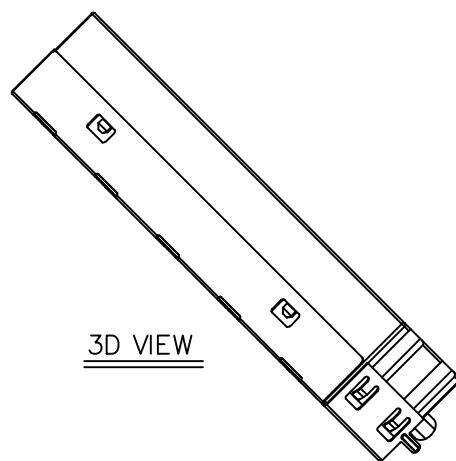
E

F

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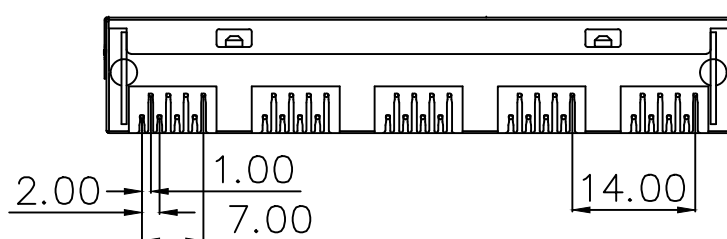


3D VIEW



RECOMMENDED PCB LAYOUT

TOP VIEW(TOL: ±0.05)



NOTES:

1. MATERIAL:

1.1. HOUSING: PBT ,COLOR IS BLACK;

1.2. CONTACT: PHOSPHOR BRONZE, $\phi 0.46 \pm 0.02$ mm;

3. RECINNEBDED PCB THICKNESS: 1.0mm Min;

4. ELECTRICAL:

4.1. VOLTAGE RATING: 125 VAC RMS;

4.2. CURRENT RATING: 1.5 AMP;

4.3. CONTACT RESISTANCE: 35MILLIOHMS MAX.;

4.4. WITHSTAND VOLTAGE: 1000 VAC RMS 50(60)Hz, 1MIN.;

4.5. INSULATION RESISTANCE: 1000MEGOHMS MIN @500V DC;

5. MECHANICAL:

5.1. MATING/UNMATING FORCE: 30N MAX.;

5.2. RETENTIION STRENGTH: 50N MIN.;

5.3. OPERATING LIFE: 750 CYCLES MIN.;

6. SALT SPRAY TEST: 12H;

7. SOLDERABILITY: $245 \pm 5^{\circ}\text{C}$, $5 \pm 0.5\text{S}$;8. RESISTANCE TO SOLDER: $260 \pm 5^{\circ}\text{C}$, $10 \pm 1\text{S}$;

9 ENVIRONMENTAL:

9.1. STORAGE TEMPERATURE RANGE: $-40^{\circ}\text{C} \sim +85^{\circ}\text{C}$;9.2. OPERATION TEMPERATURE RANGE: $-25^{\circ}\text{C} \sim +70^{\circ}\text{C}$;

3	外壳	铜	镀镍	
2	接触	铜	镀金G/F	
1	基座	PBT	黑色	
序号	品 名	材 质	电镀/颜色	备 注



深圳市虹成电子有限公司

品 名 TITLE	网 口
料 号 PART NO	HC-WK88-H132-1X5-55B

UNLESS OTHERWISE,
GENERAL TOLERANCE:X. xxx ± 0.10
X. xx ± 0.20
X. x ± 0.30

ANGULAR:

X. xx° $\pm 1^{\circ}$
X. x° $\pm 3^{\circ}$
X. ° $\pm 5^{\circ}$ 比 列
SCALE

1:1

单 位
UNIT

MM

张 数
PART NO

1 OF 1

版 本
REV

A

制 图
DRAW

AhYe

审 核
CHECKED

夏操云

批 准
APPROVE

赵亮亮

